

FIG. 1A

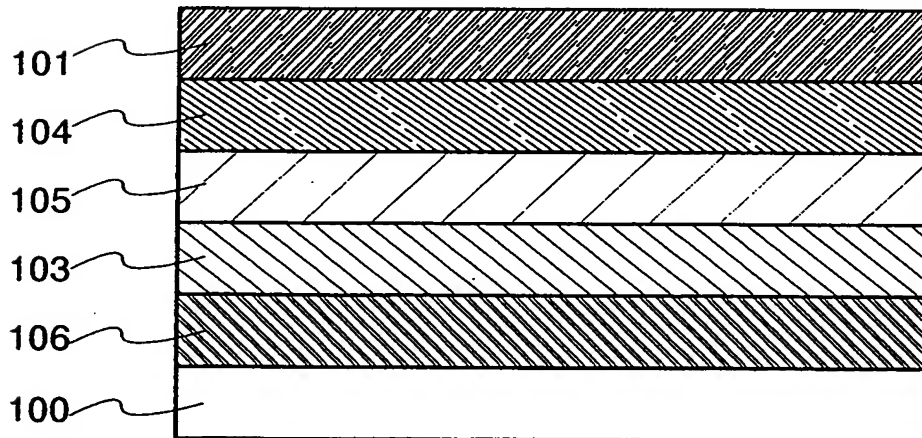


FIG. 1B

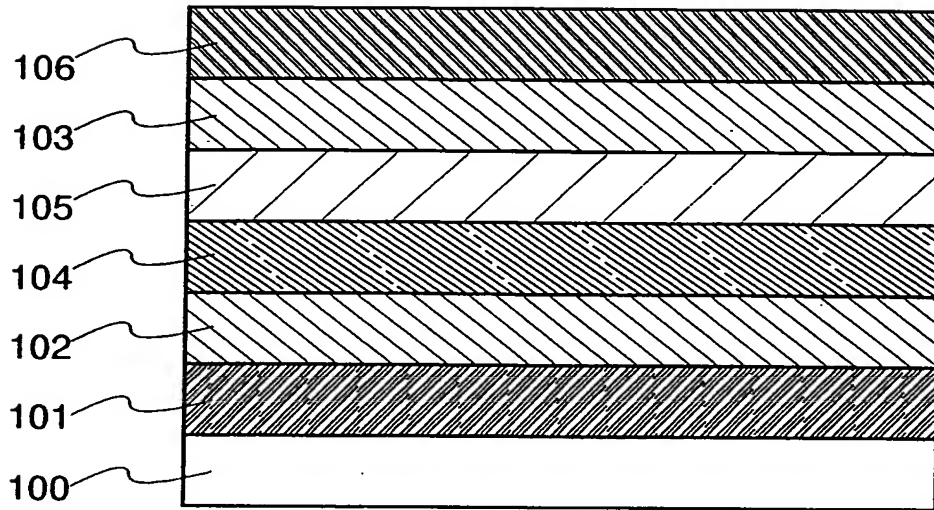


FIG. 2A

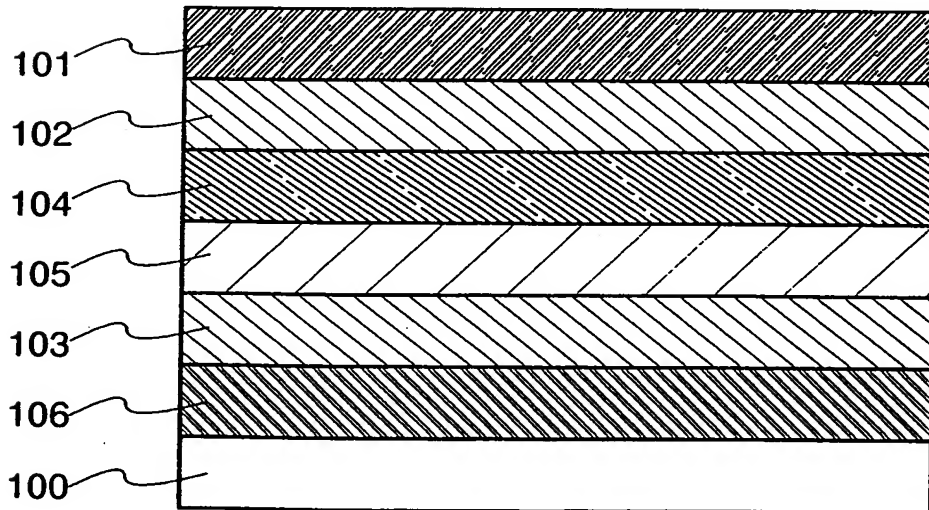


FIG. 2B

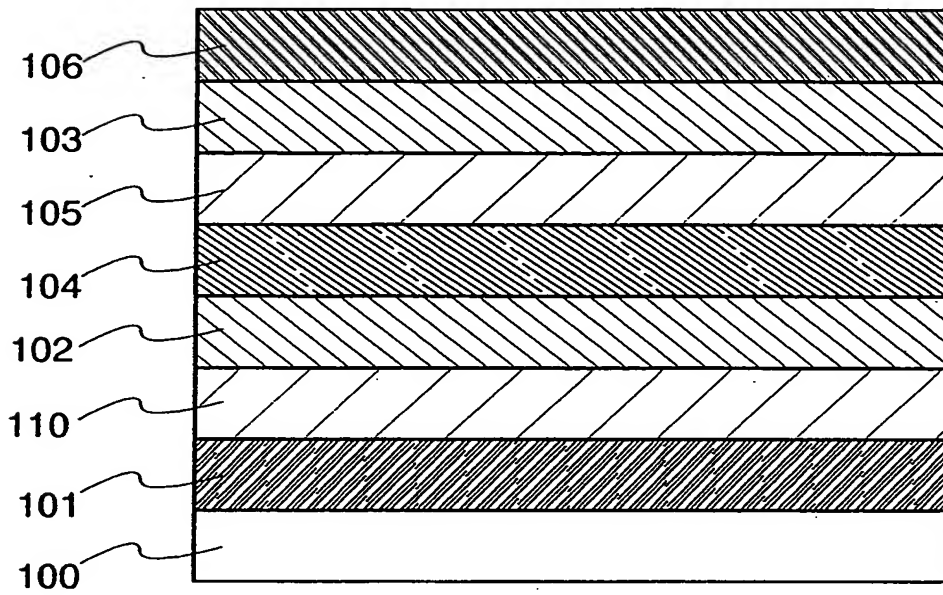


FIG. 3A

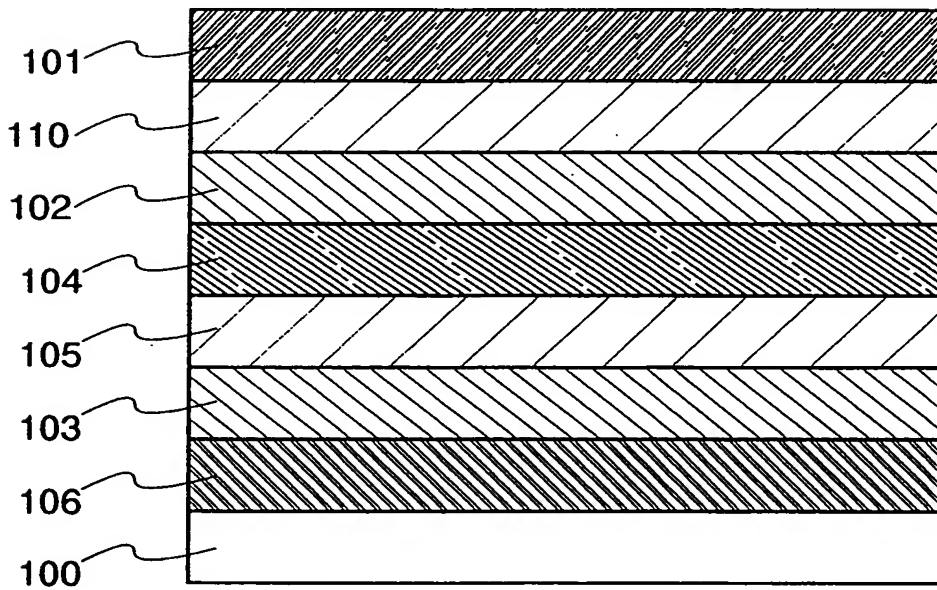


FIG. 3B

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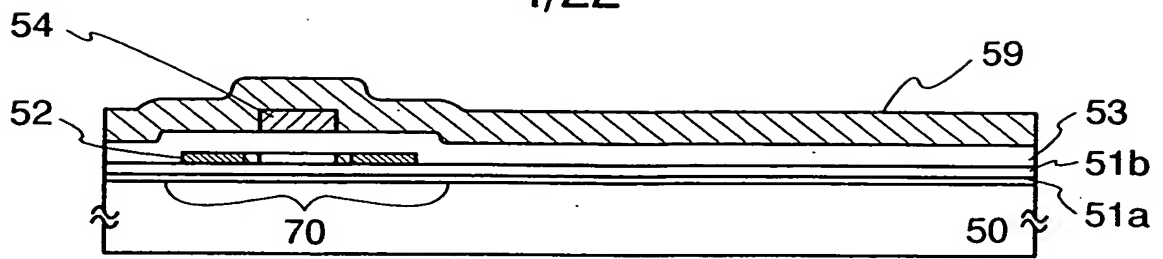


FIG. 4A

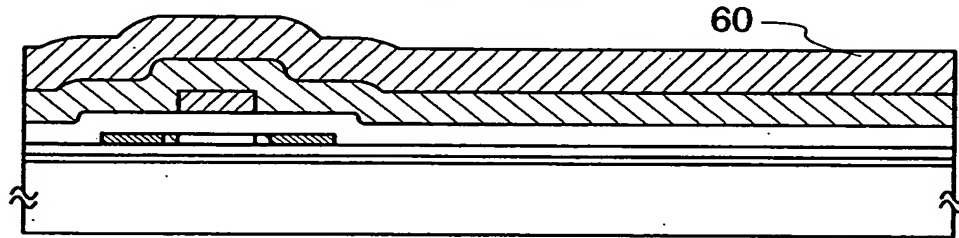


FIG. 4B

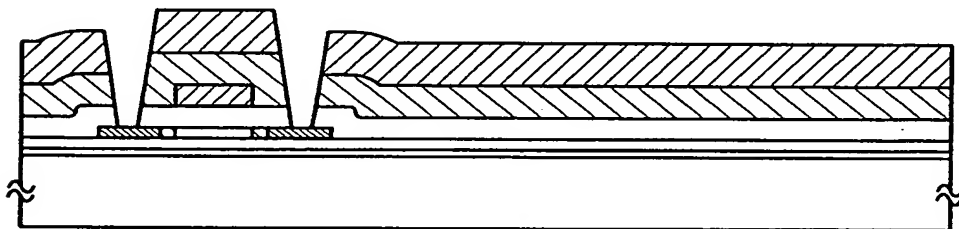


FIG. 4C

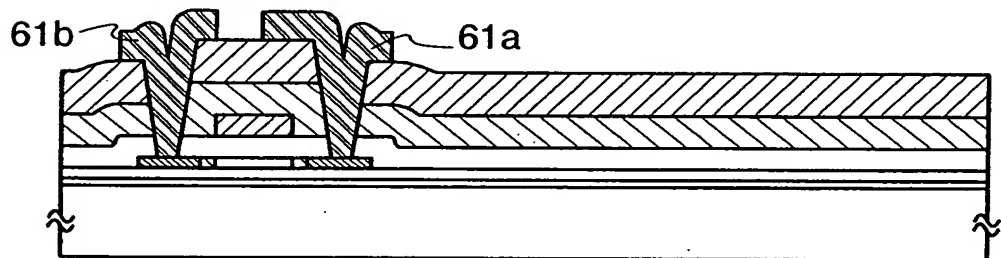


FIG. 4D

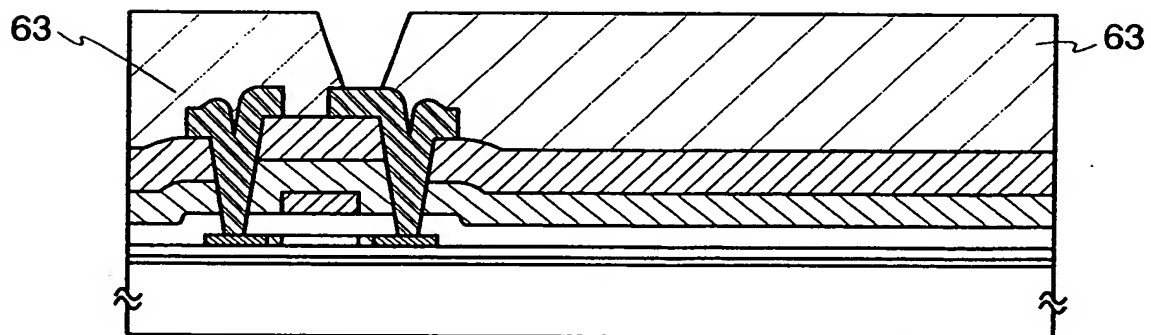


FIG. 4E

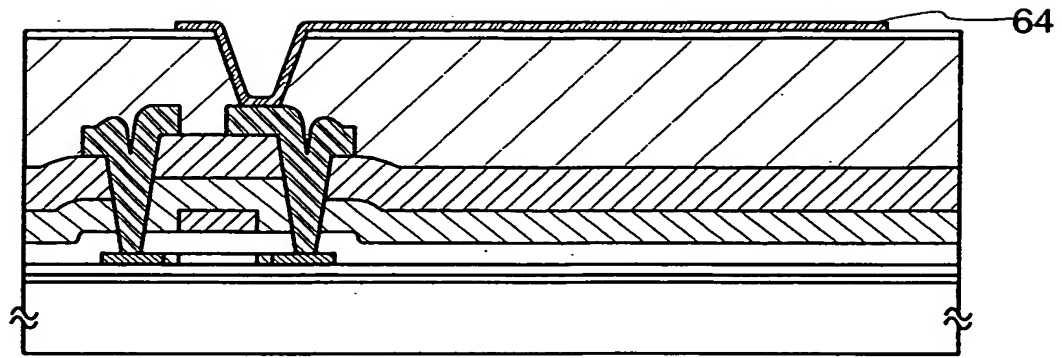


FIG. 5A

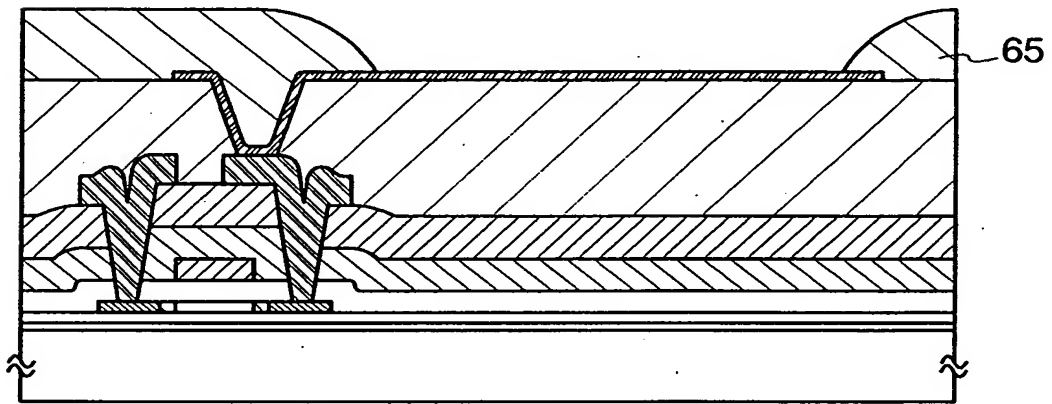


FIG. 5B

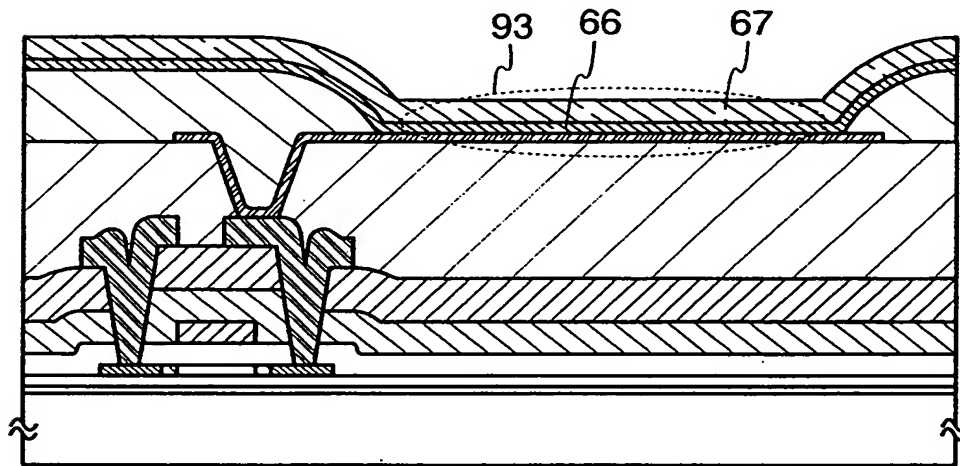


FIG. 5C

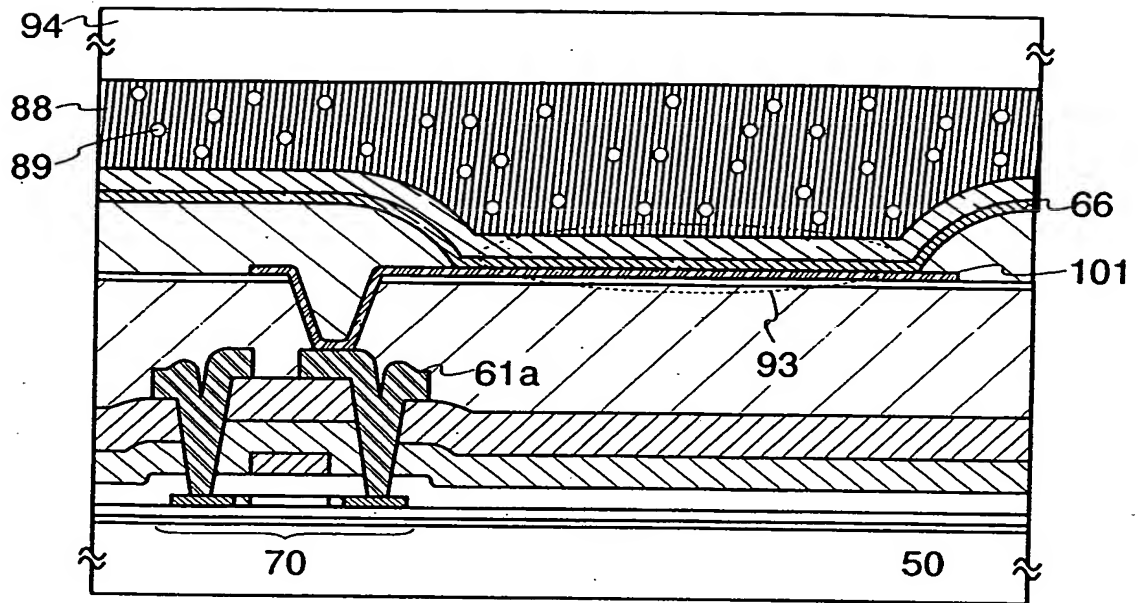


FIG. 6A

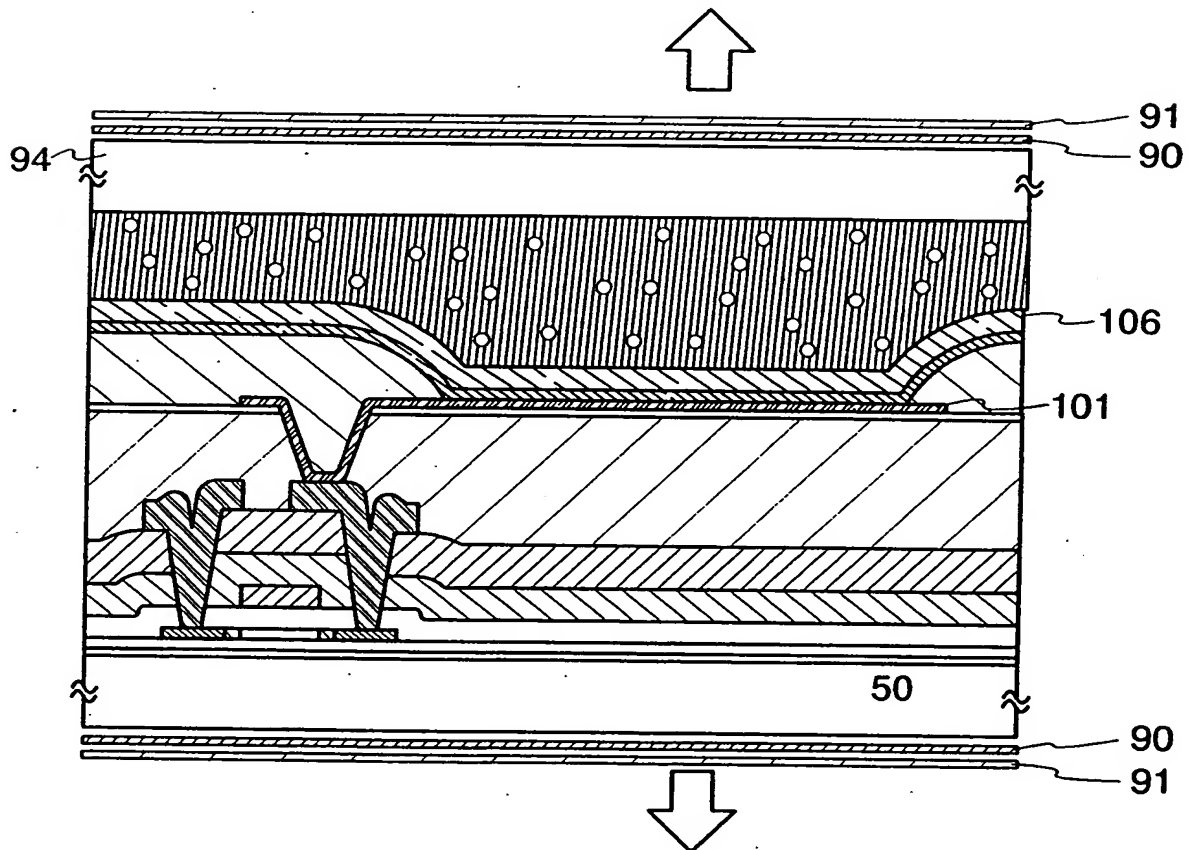


FIG. 6B

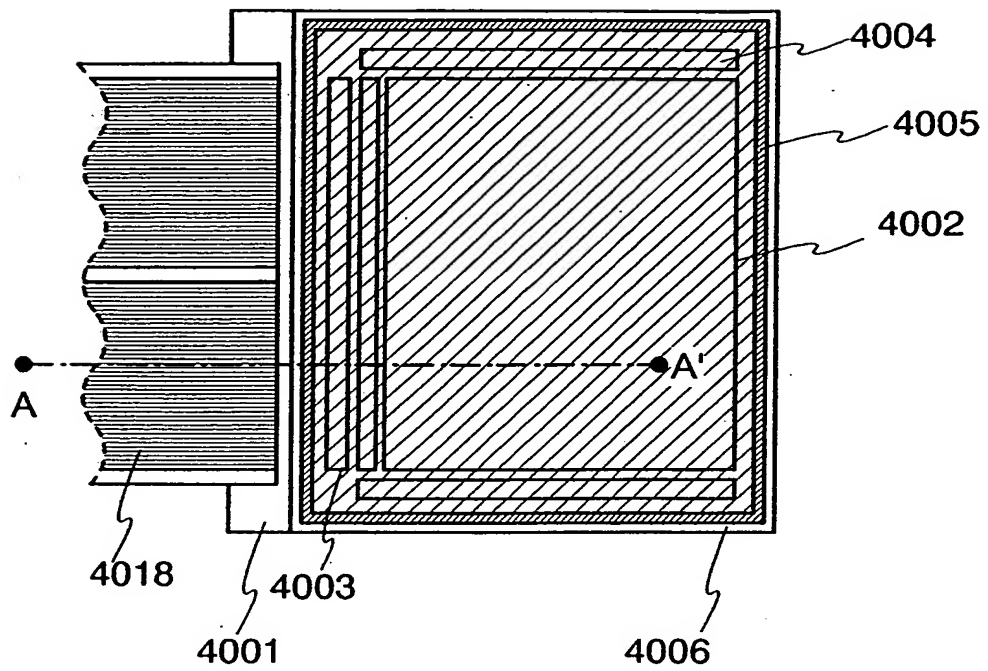


FIG. 7A

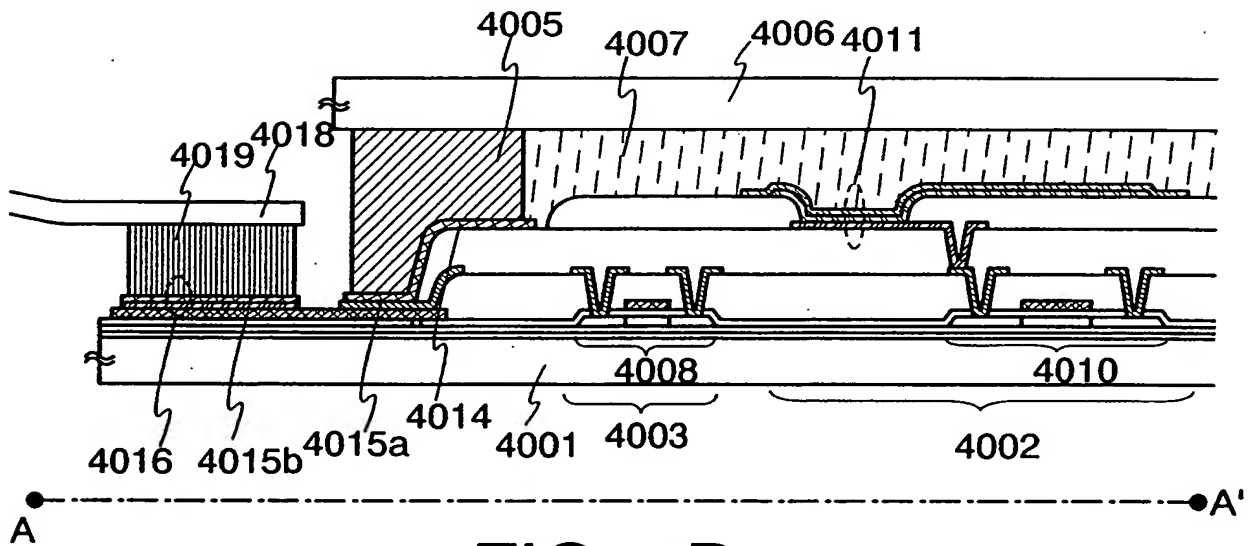


FIG. 7B

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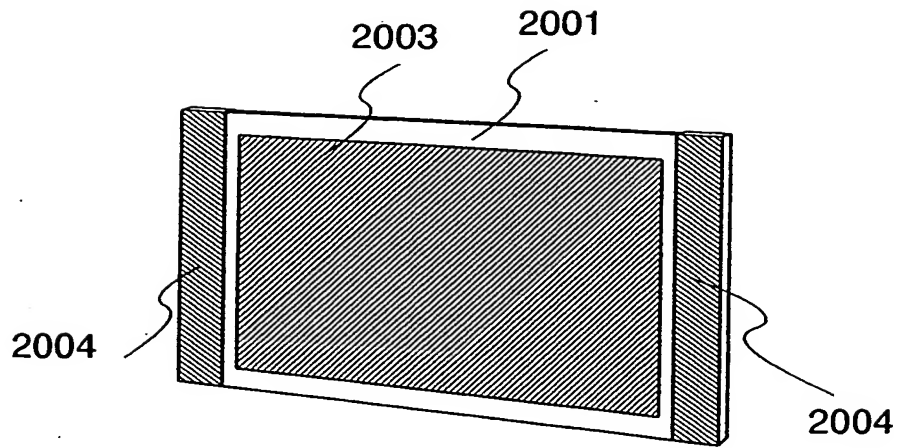


FIG. 8A

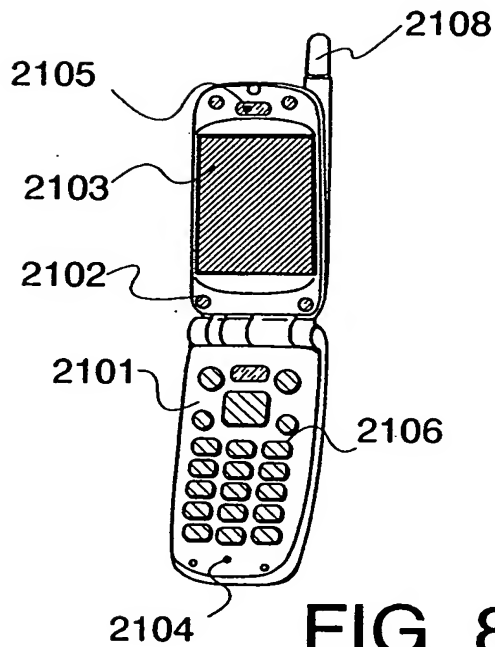


FIG. 8B

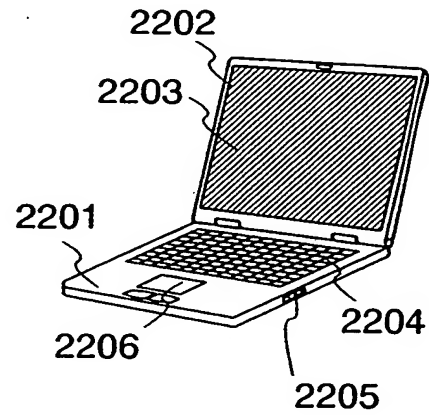


FIG. 8C

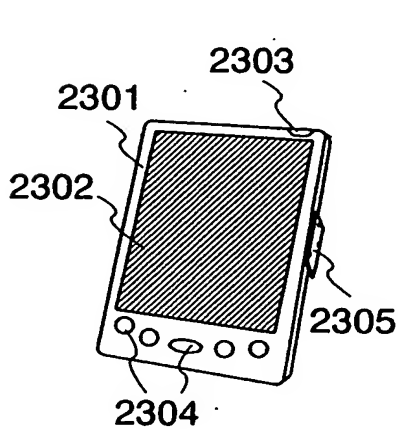


FIG. 8D

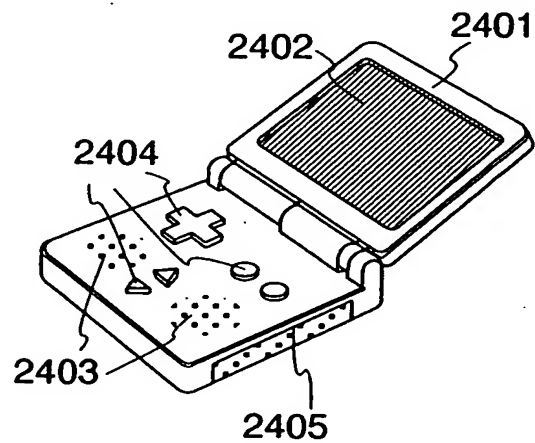


FIG. 8E

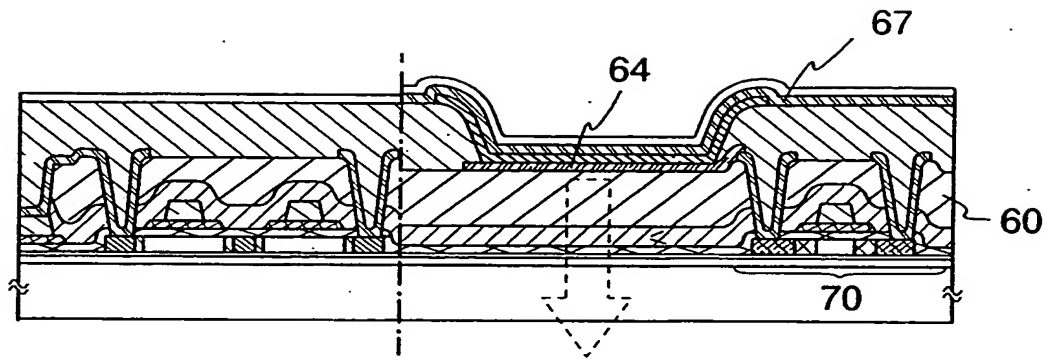


FIG. 9A

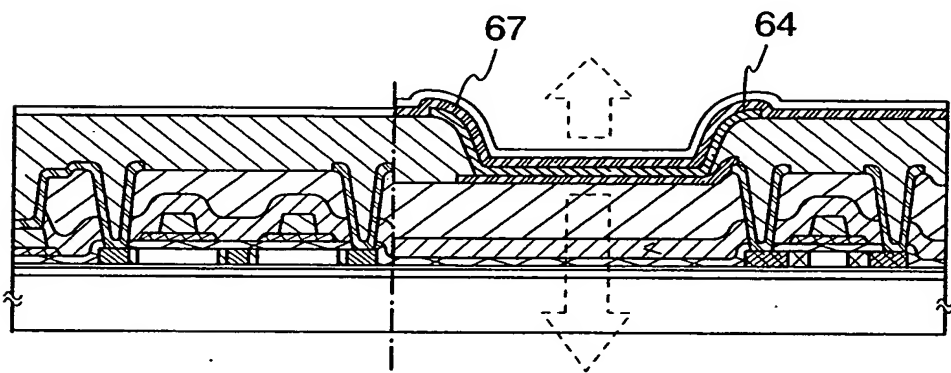


FIG. 9B

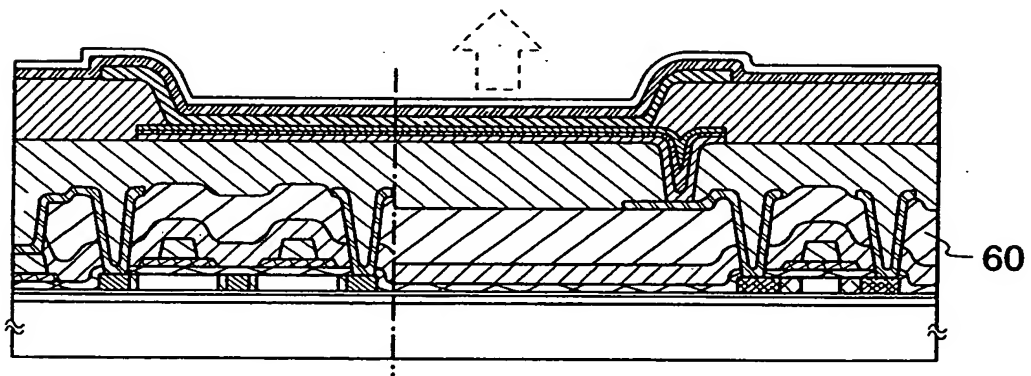


FIG. 9C

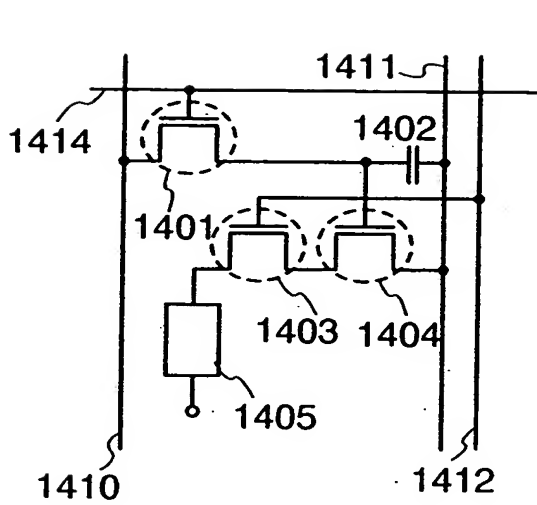


FIG. 10A

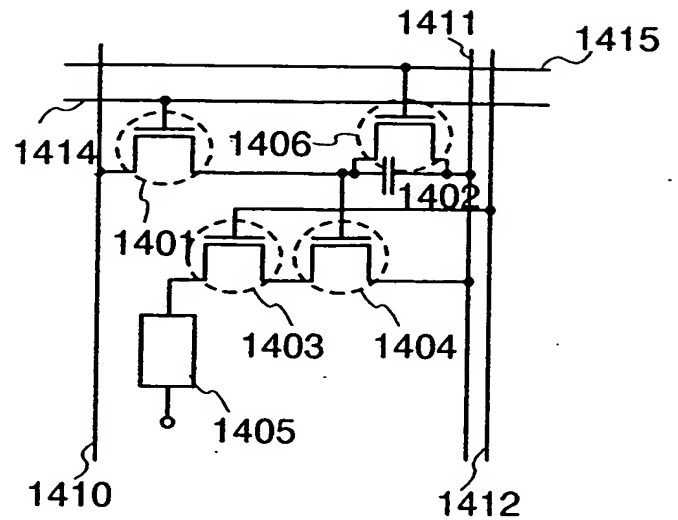


FIG. 10B

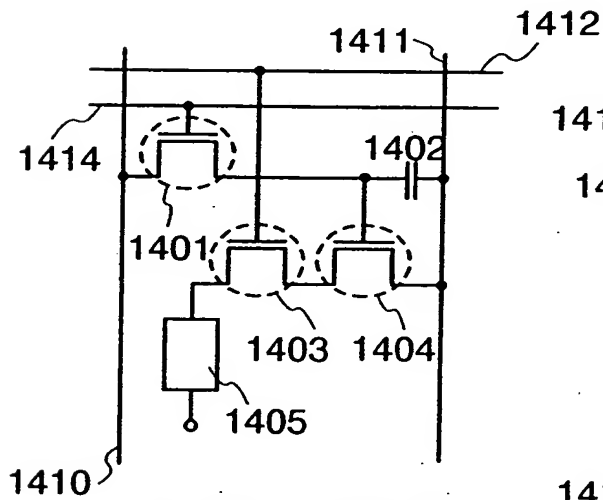


FIG. 10C

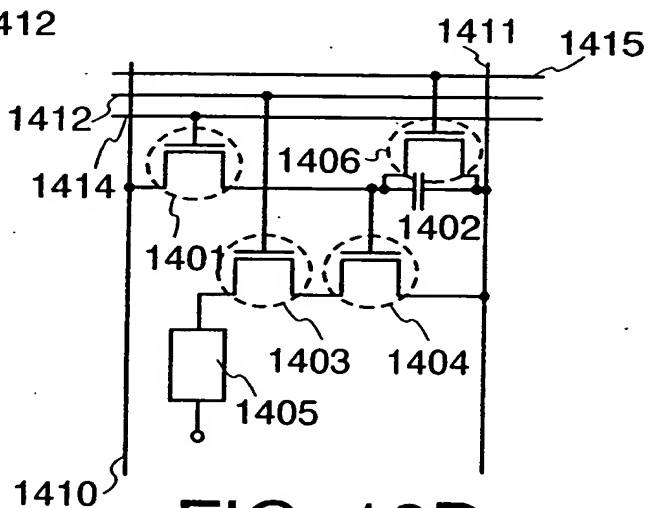


FIG. 10D

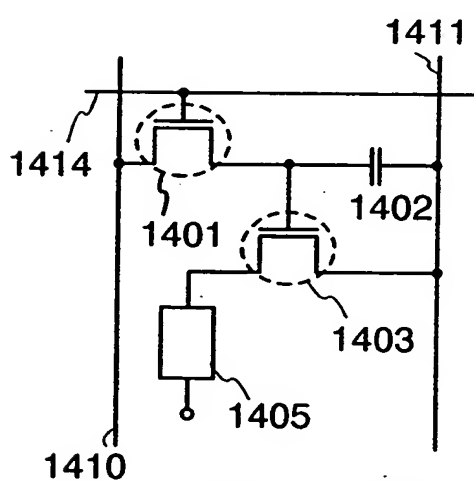


FIG. 10E

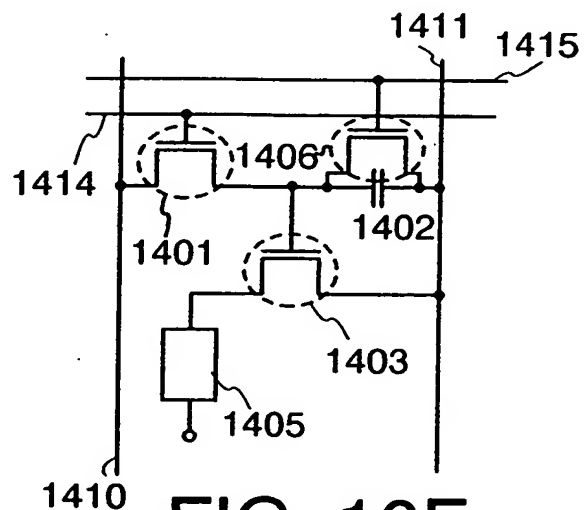


FIG. 10F

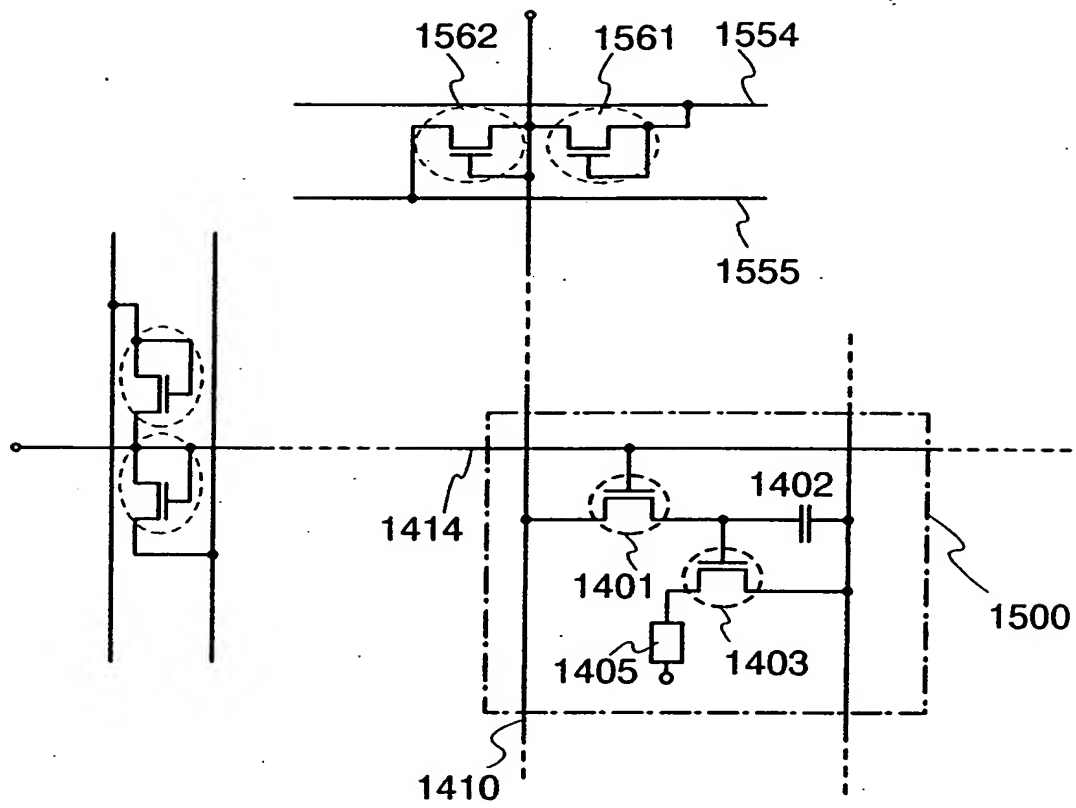


FIG. 11

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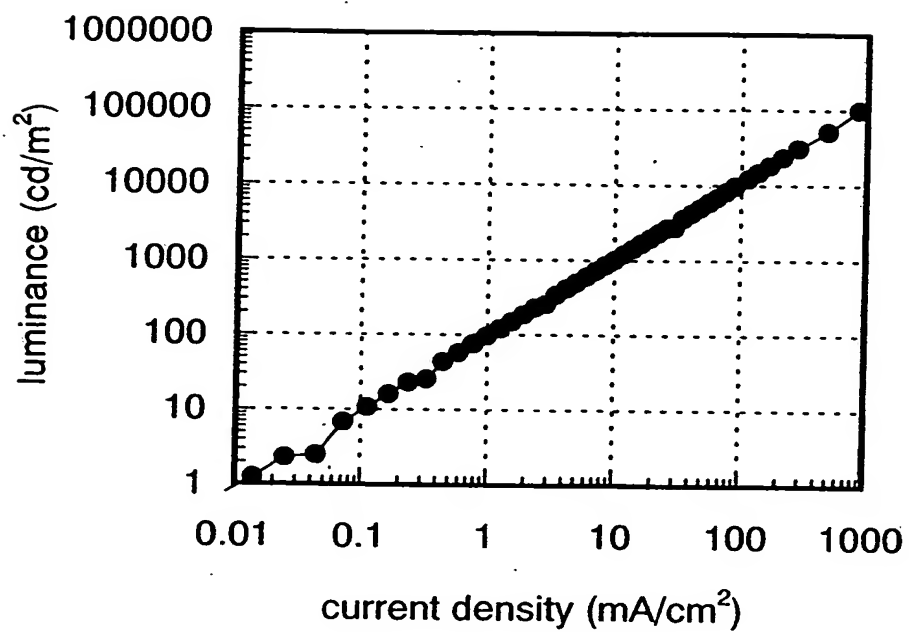


FIG. 12

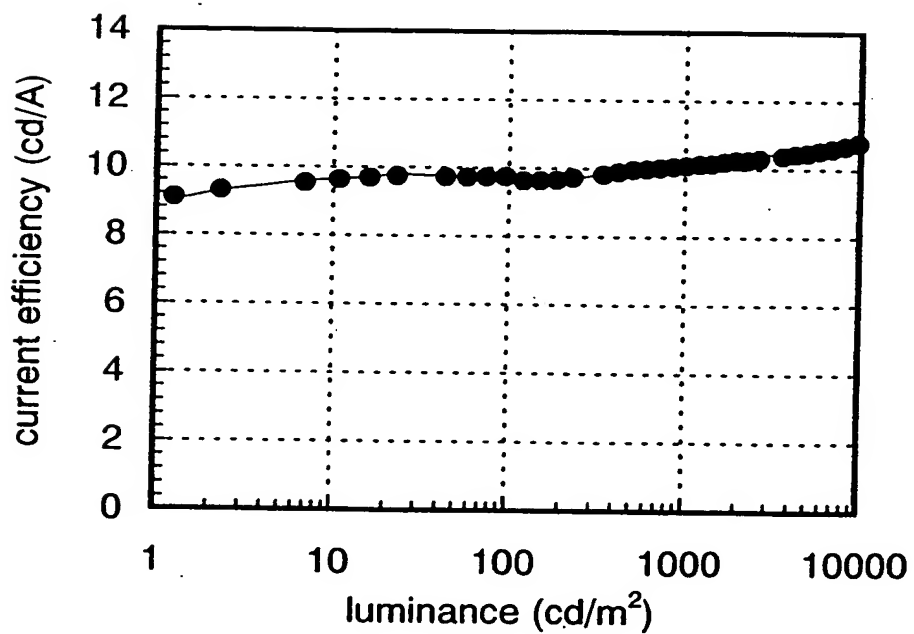


FIG. 13

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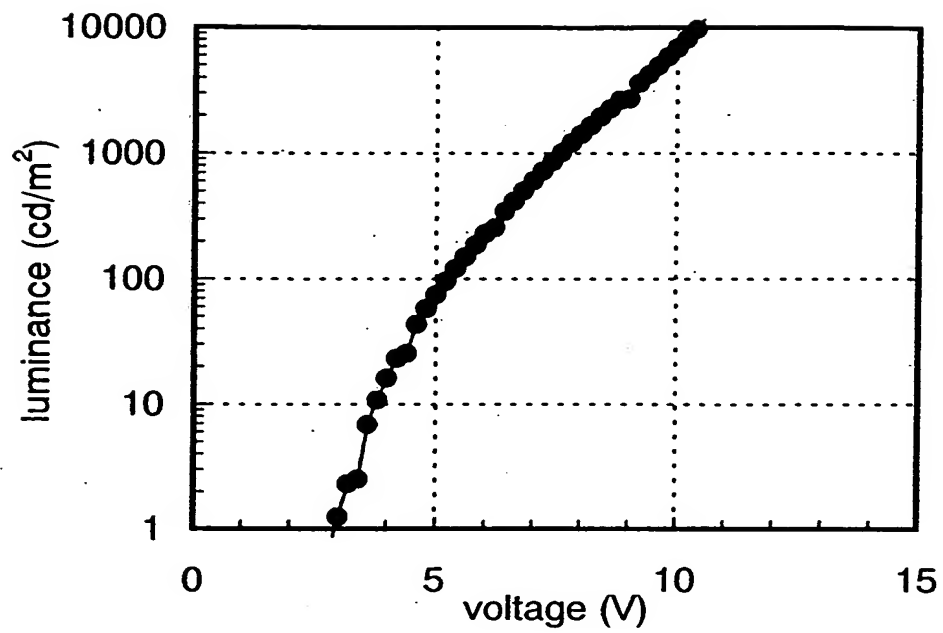


FIG. 14

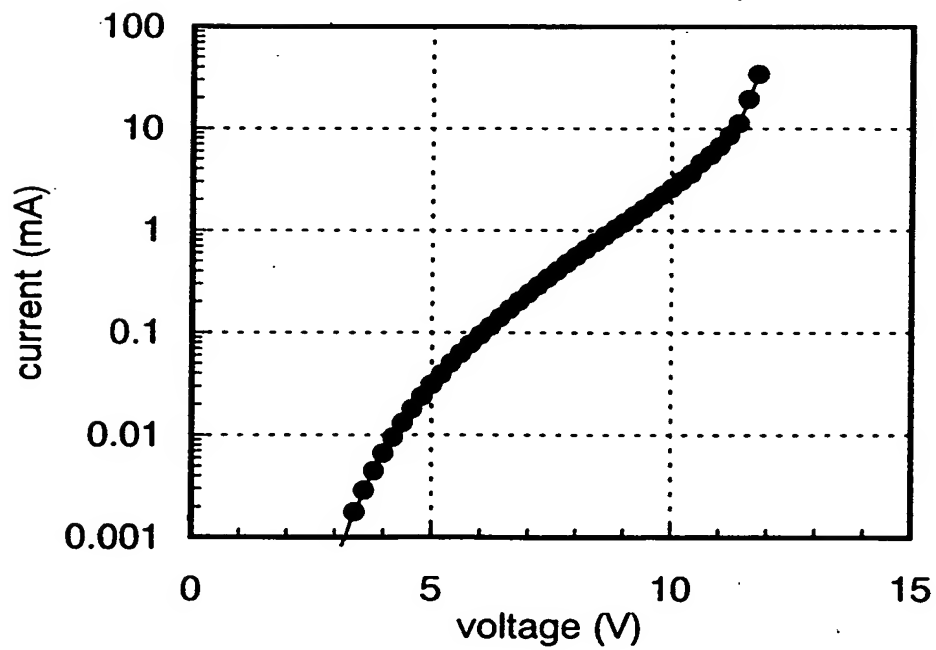


FIG. 15

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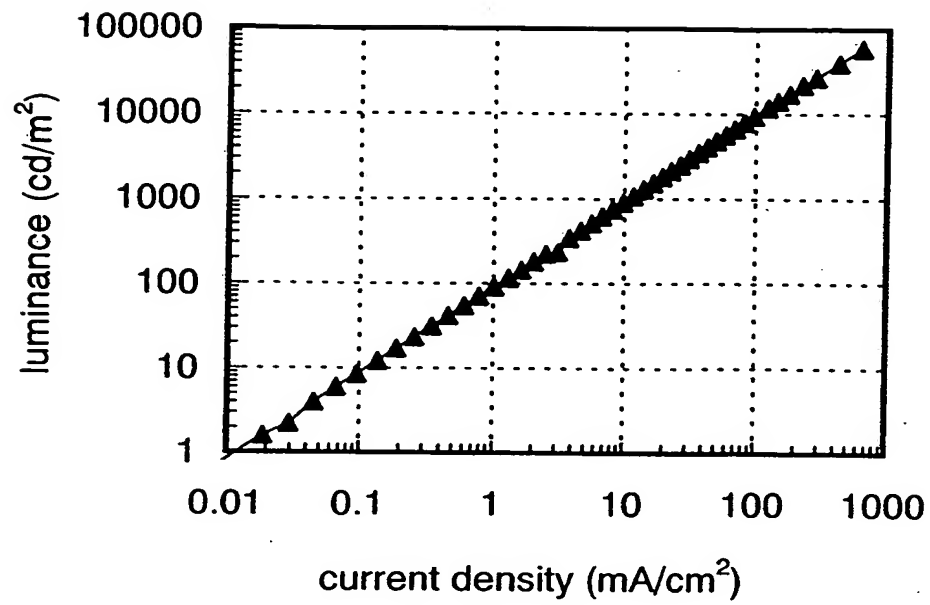


FIG. 16

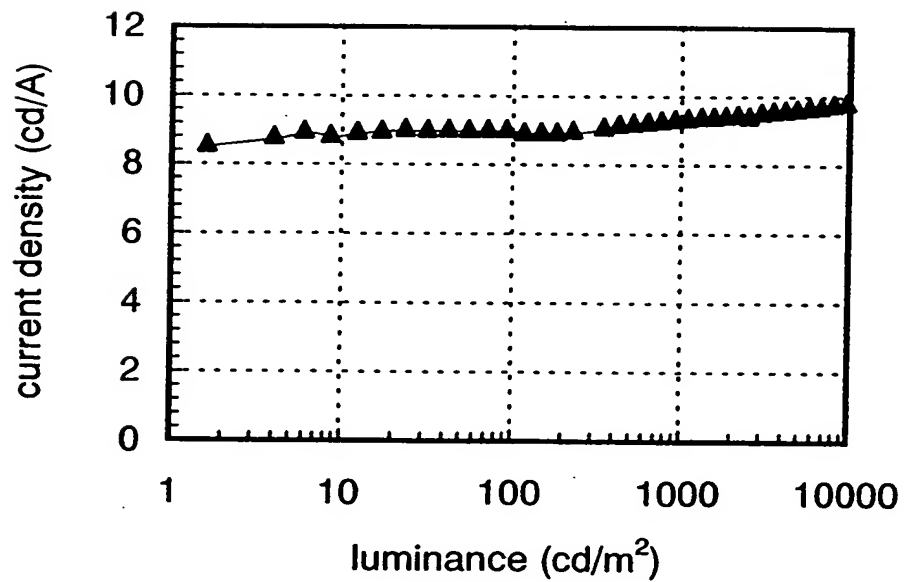


FIG. 17

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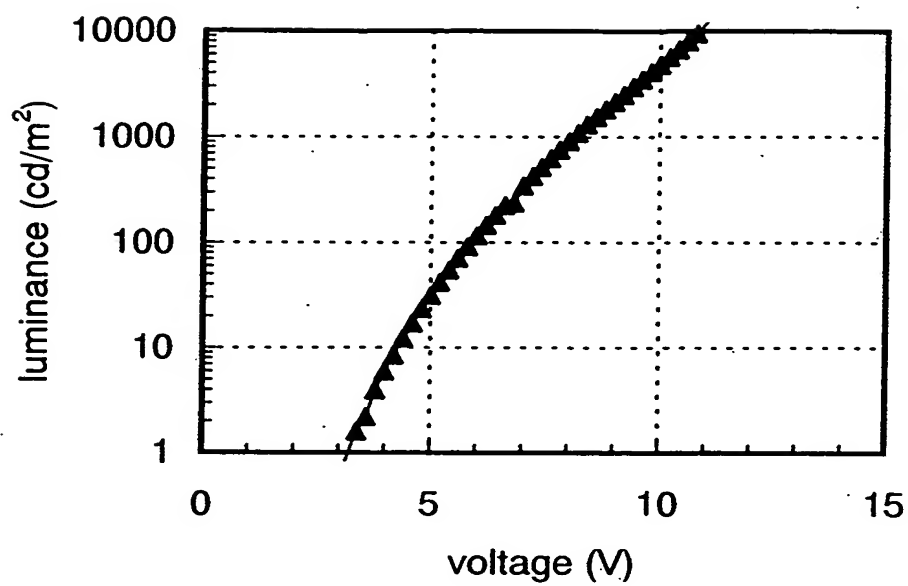


FIG. 18

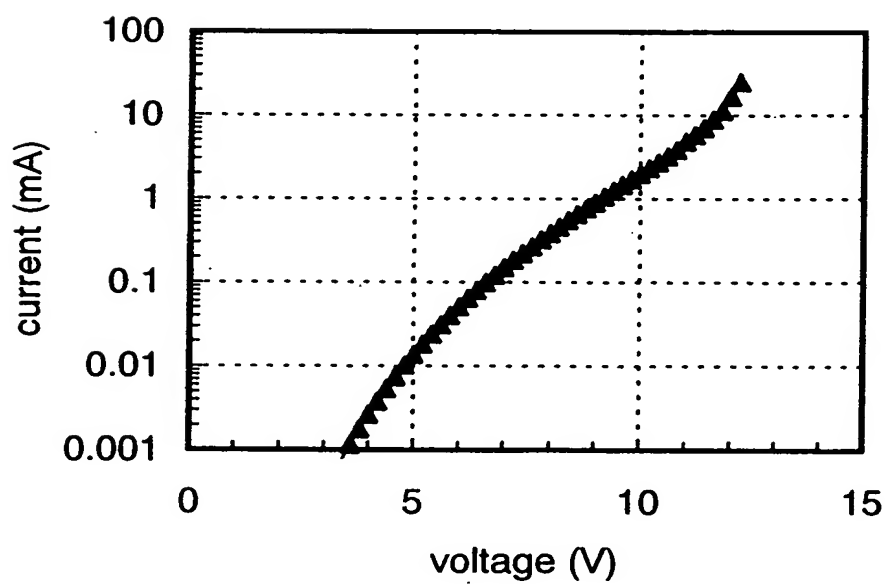


FIG. 19

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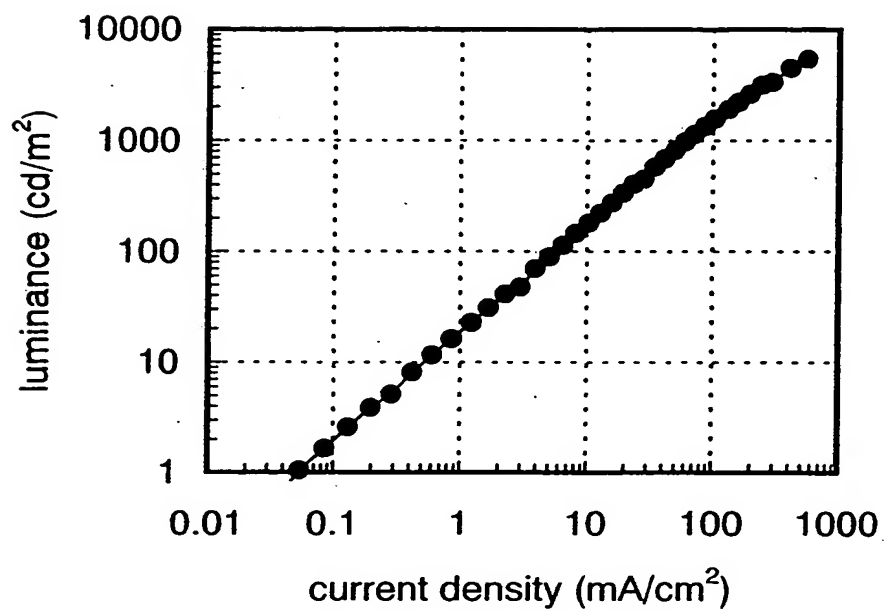


FIG. 20

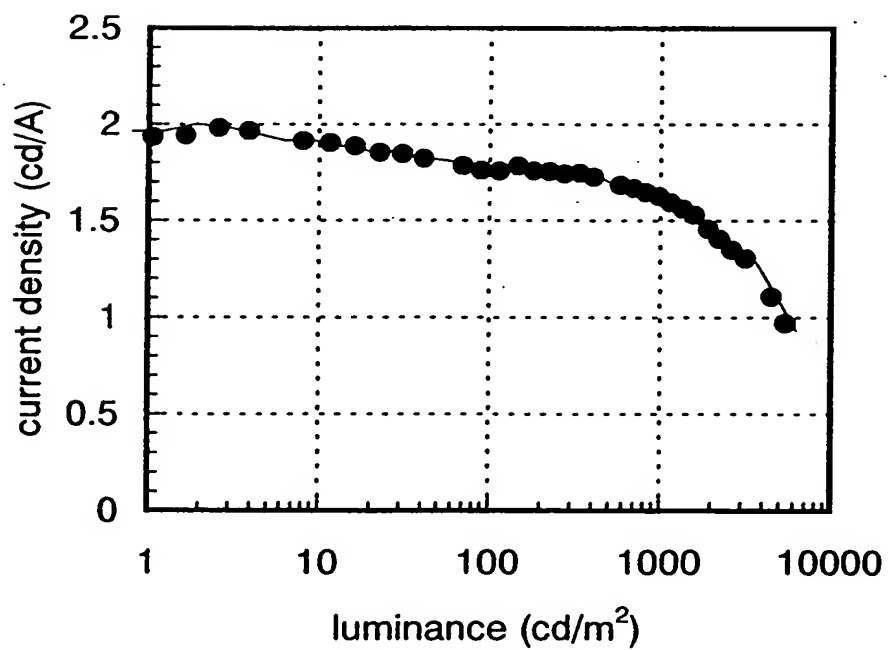


FIG. 21

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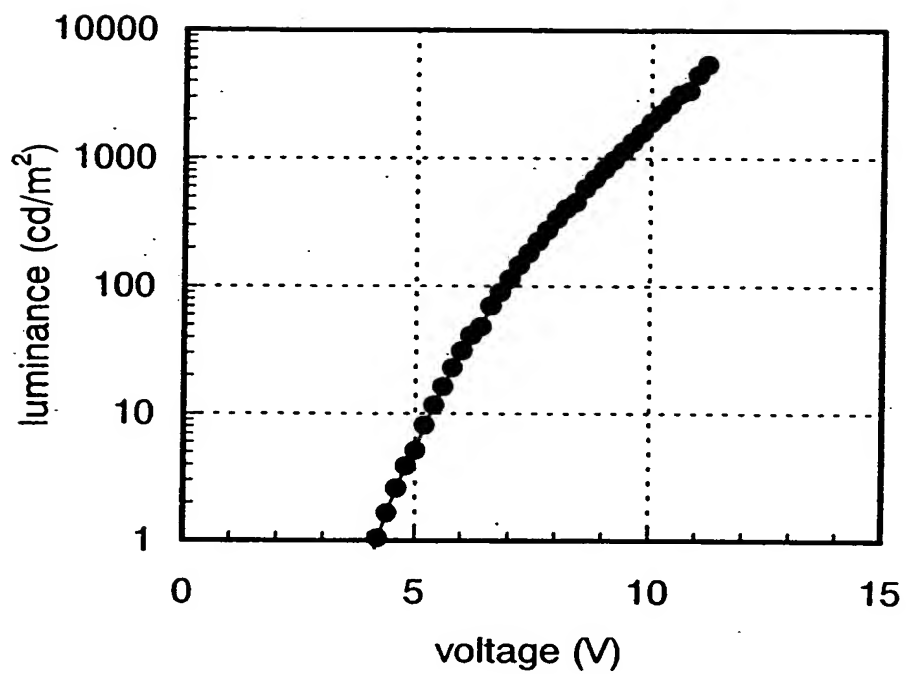


FIG. 22

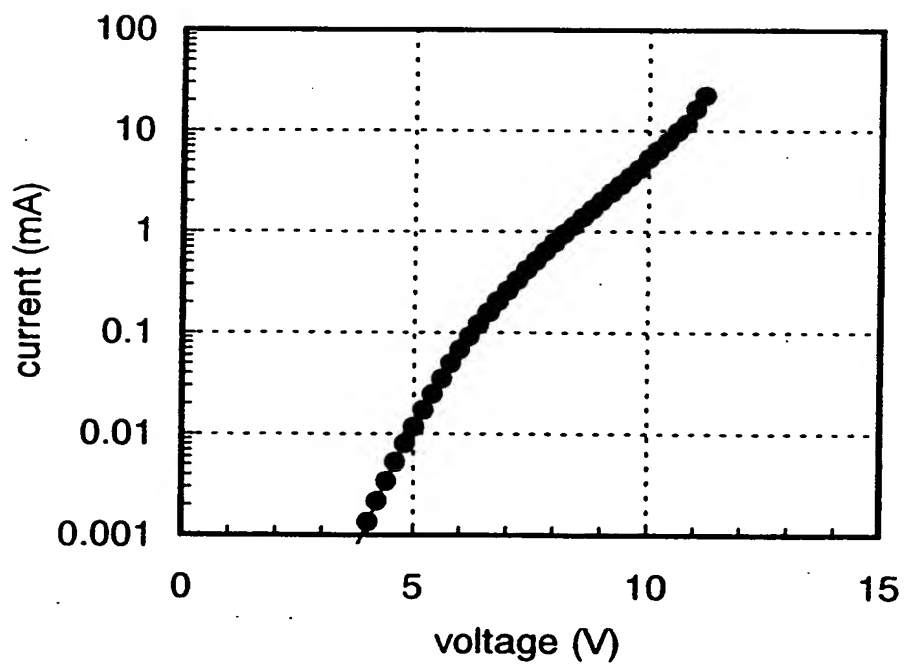


FIG. 23

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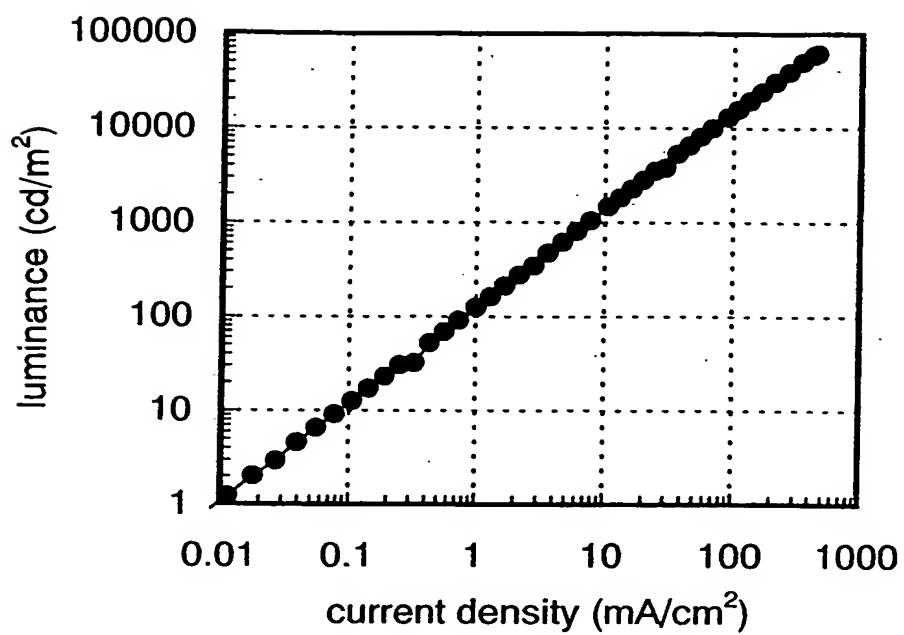


FIG. 24

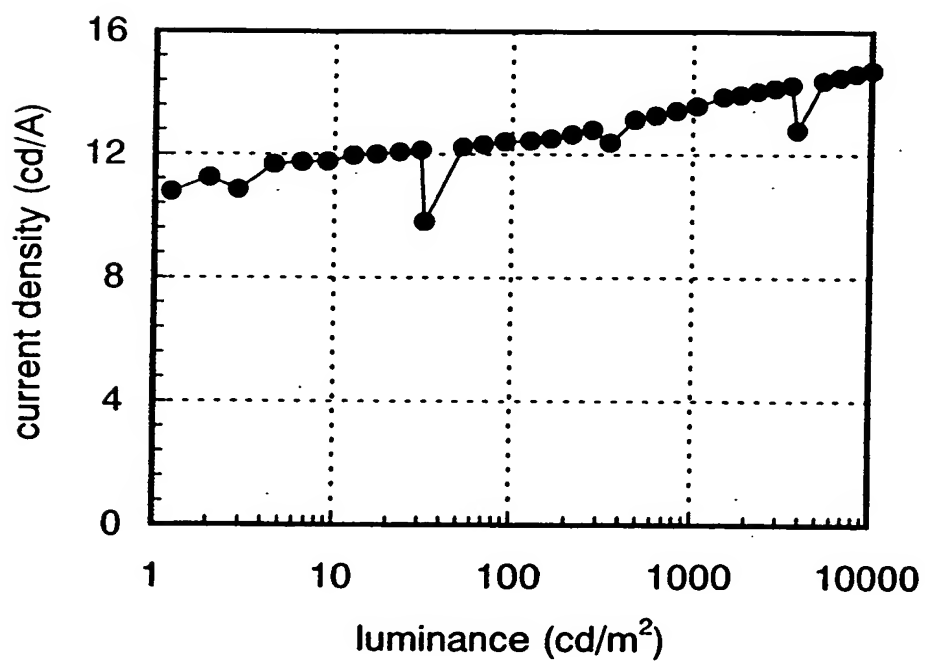


FIG. 25

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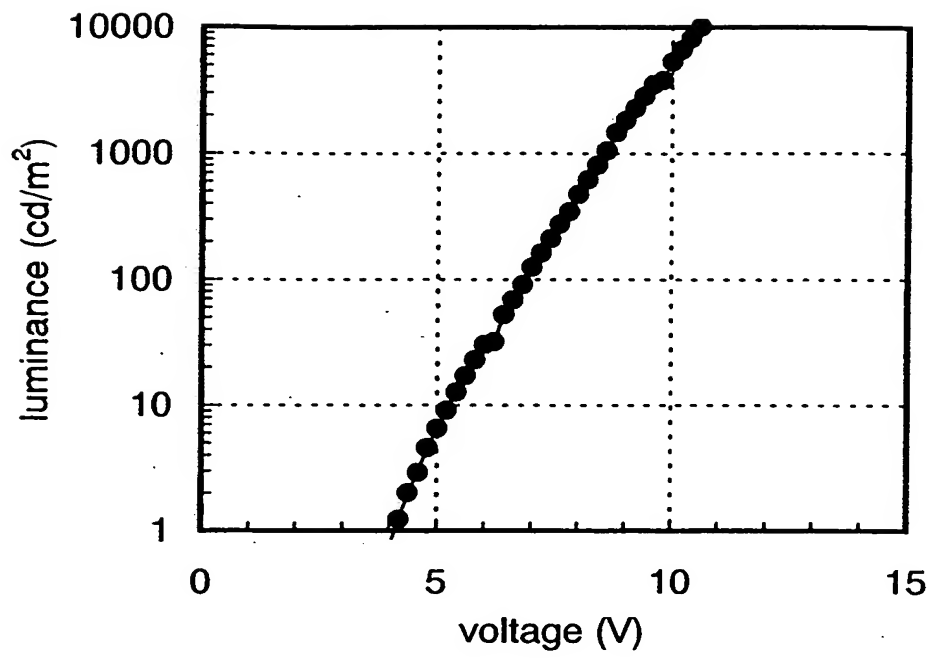


FIG. 26

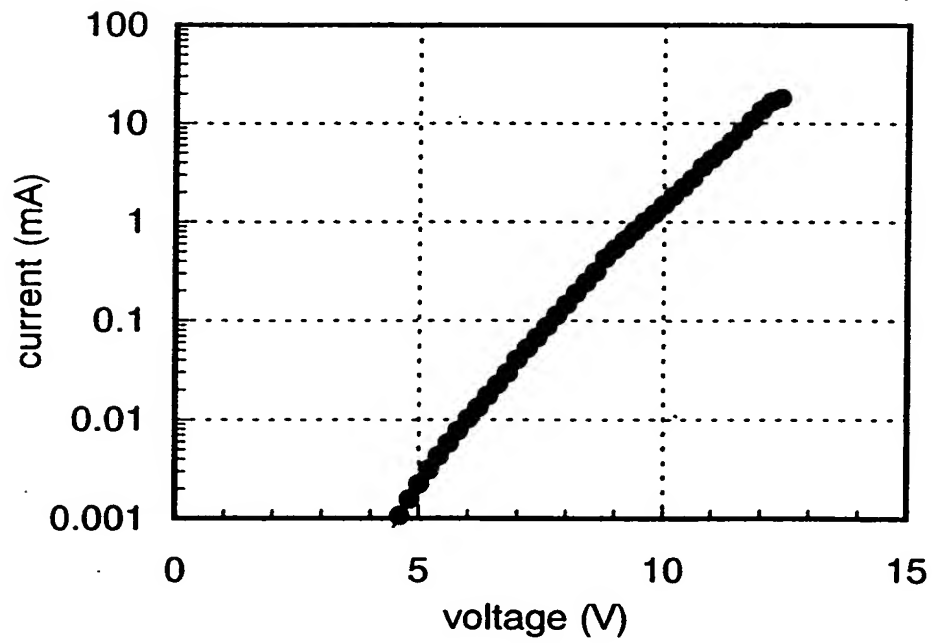


FIG. 27

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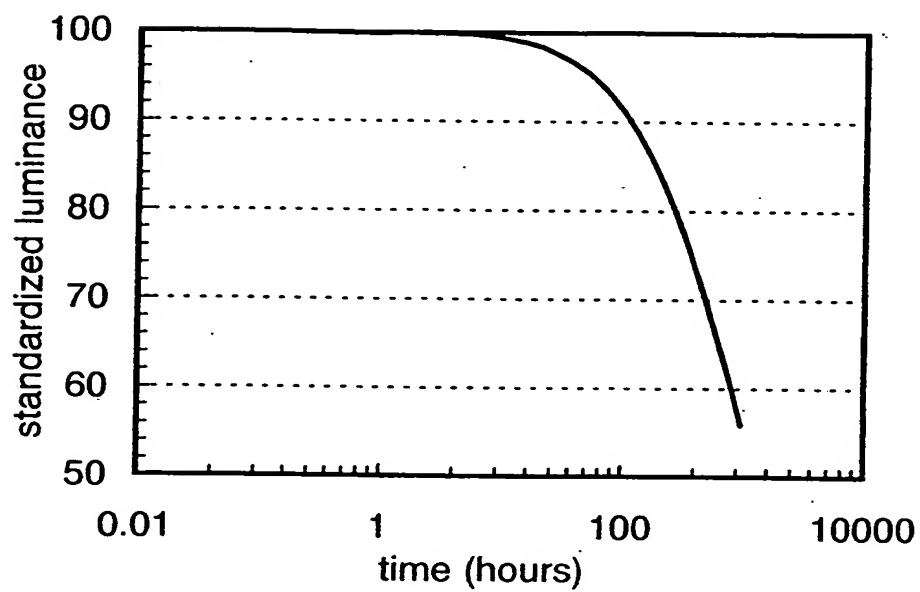


FIG. 28

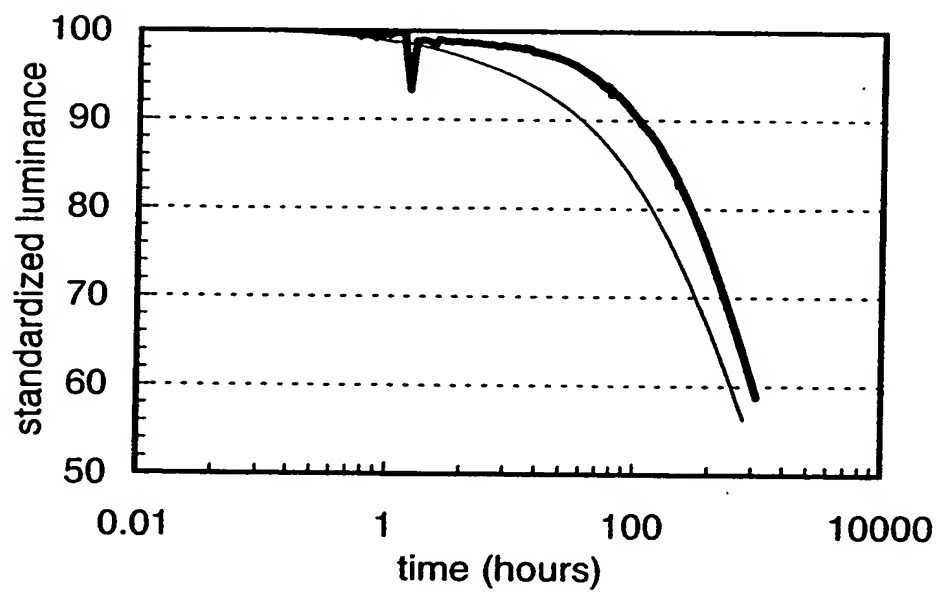


FIG. 29

EXPLANATION OF REFERENCE

50: substrate, 51a: base insulating layer, 51b: base insulating layer, 52: semiconductor layer, 53: gate insulating layer, 54: gate electrode, 59: insulating film (hydrogenated film), 60: interlayer insulating layer, 61a: connection portion, 61b: wiring, 63: interlayer insulating layer, 65: partition wall, 66: light emitting laminated body, 70: thin film transistor, 88: resin, 89: drying agent, 90: polarizing plate, 91: protection film, 93: light emitting element, 94: counter substrate, 100: insulating material, 101: electrode, 102: layer, 103: layer, 104: light emitting laminated body, 105: layer, 106: electrode, 110: layer, 900: interlayer insulating layer, 901: thin film transistor, 1401: switching TFT, 1402: capacitor element, 1403: driving TFT, 1404: current controlling TFT, 1405: light emitting element, 1406: TFT, 1410: signal line, 1411: power supply line, 1412: power supply line, 1414: scanning line, 1415: scanning line, 1500: pixel portion, 1554:

common potential line, 1561: diode, 2001: housing, 2003: display portion, 2004; speaker portion, 2101: main body, 2102: housing, 2103: display portion, 2104: audio input portion, 2105: audio output portion, 2106: operation key, 2108: antenna, 2201: main body, 2202: housing, 2203: display portion, 2204: keyboard, 2205: external connection port, 2206: pointing mouse, 2301: main body, 2302: display portion, 2303: switch, 2304: operation key, 2305: infrared port, 2401: housing, 2402: display portion, 2403: speaker portion, 2404: operation key, 2405: recording medium insertion portion, 4001: substrate, 4002: pixel portion, 4003: signal line driver circuit, 4004: scanning line driver circuit, 4005: sealing material, 4006: counter substrate, 4007: filler, 4008: thin film transistor, 4010: thin film transistor, 4011: light emitting element, 4014: wiring, 4016: connection terminal, 4018: flexible printed circuit (FPC), 4019: anisotropic conductive film, 4015a: wiring, 4015b: wiring